

Photo DMOS-FET Relay

Description

The **LT611-1** is a miniature 1-Form A solid state relay in a 4 pin SMD package that employs optically coupled MOSFET technology to provide 5000V of input to output isolation. The optically coupled input is controlled by a highly efficient GaAlAs infrared LED and MOS FETs on the output side.

Features

- Low driver power requirements (TTL/CMOS Compatible)
- High reliability
- Arc-Free with no snubbing circuits
- 5000Vrms Input/Output isolation
- Tape & Reel version available

Applications

- Telecommunications (PC, Electronic notepad)
- Measuring and Testing equipment
- Industrial control
- Security equipments
- High speed inspection machine

Outline Dimensions

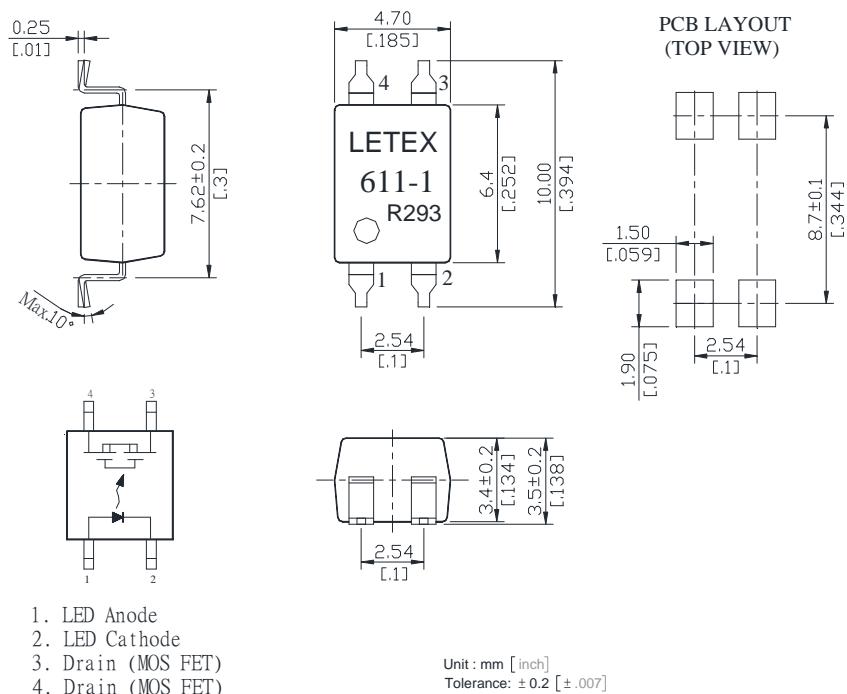


Photo DMOS-FET Relay Specifications

Part Name: LT611-1

(Load voltage: 350V / Load current: 130mA)

Absolute Maximum Ratings (Ambient Temperature: 25°C)

Item		Symbol	Value	Units	Note
Input	Continuous LED Current	I _F	50	mA	
	Peak LED Current	I _{FP}	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	V _R	5	V	
	Input Power Dissipation	P _{In}	75	mW	
Output	Load Voltage	V _L	350	V(AC peak or DC)	
	Load Current	I _L	130	mA	
	Peak Load Current	I _{Peak}	0.6	A	100ms(1 pulse)
	Output Power Dissipation	P _{out}	300	mW	
Total Power Dissipation		P _T	350	mW	
I/O Breakdown Voltage		V _{I/O}	5000	Vrms	RH=60%, 1min
Operating Temperature		T _{Op}	-40 to +85	°C	
Storage Temperature		T _{Stg}	-40 to +100	°C	
Pin Soldering Temperature		T _{Sol}	260	°C	10 sec max.

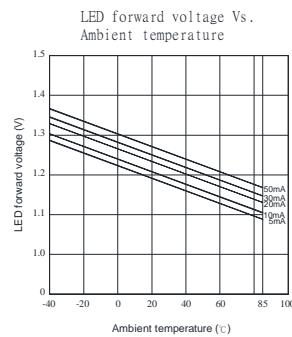
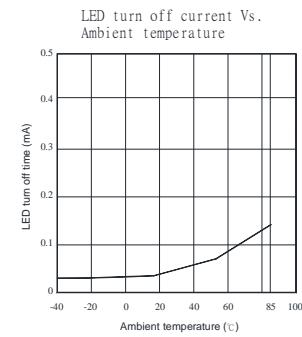
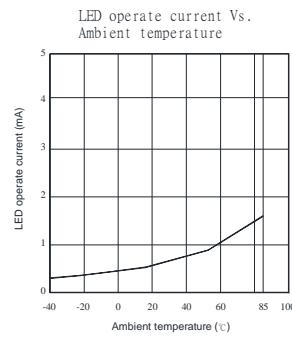
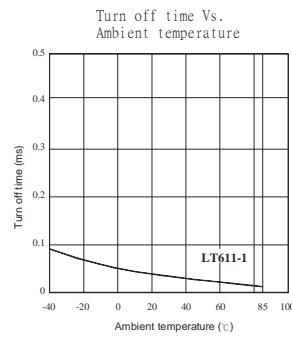
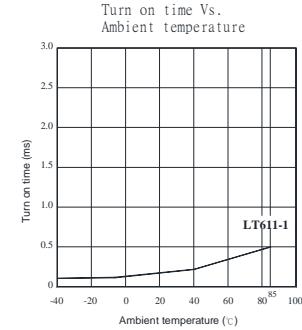
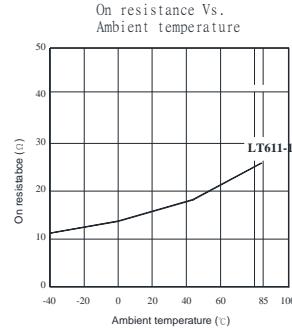
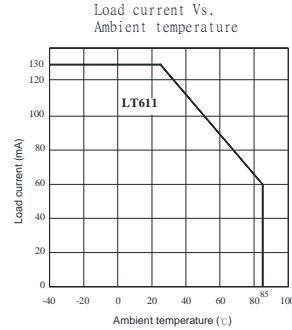
Electrical Specifications (Ambient Temperature: 25°C)

Item		Symbol	MIN.	TYP.	MAX.	Units	Conditions
Input	LED Forward Voltage	V _F		1.2	1.4	V	I _F =10mA
	Operation LED Current	I _{F On}		0.5	1.0	mA	
	Recovery LED Current	I _{F Off}		0.35	0.5	mA	
	Recovery LED Voltage	V _{F Off}	0.7			V	
Output	On-Resistance	R _{On}		17	24	Ω	I _F =5mA, I _L =100mA, Time to flow is within 1 sec.
	Off-State Leakage Current	I _{Leak}			1	uA	V _L =Rating
	Output Capacitance	C _{out}		115		pF	V _L =0, f=1MHz
Transmission	Turn-On Time	T _{On}		0.23	0.5	ms	I _F =5mA, I _L =100mA,
	Turn-Off Time	T _{off}		0.05	0.2	ms	
Coupled	I/O Isolation Resistance	R _{I/O}	10 ¹⁰			Ω	DC500V
	I/O Capacitance	C _{I/O}		0.8	1.5	pF	f=1MHz

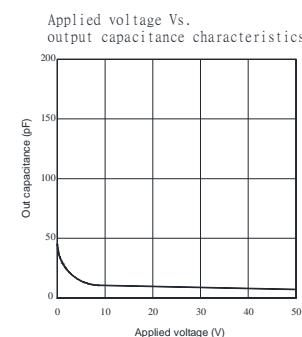
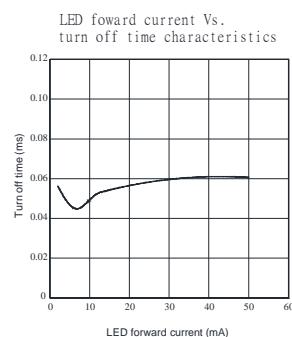
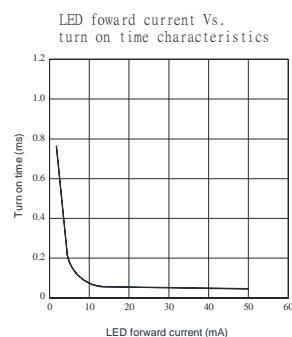
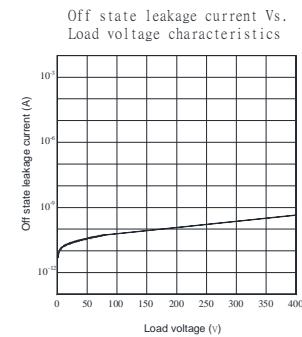
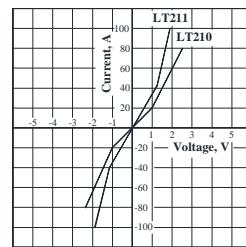


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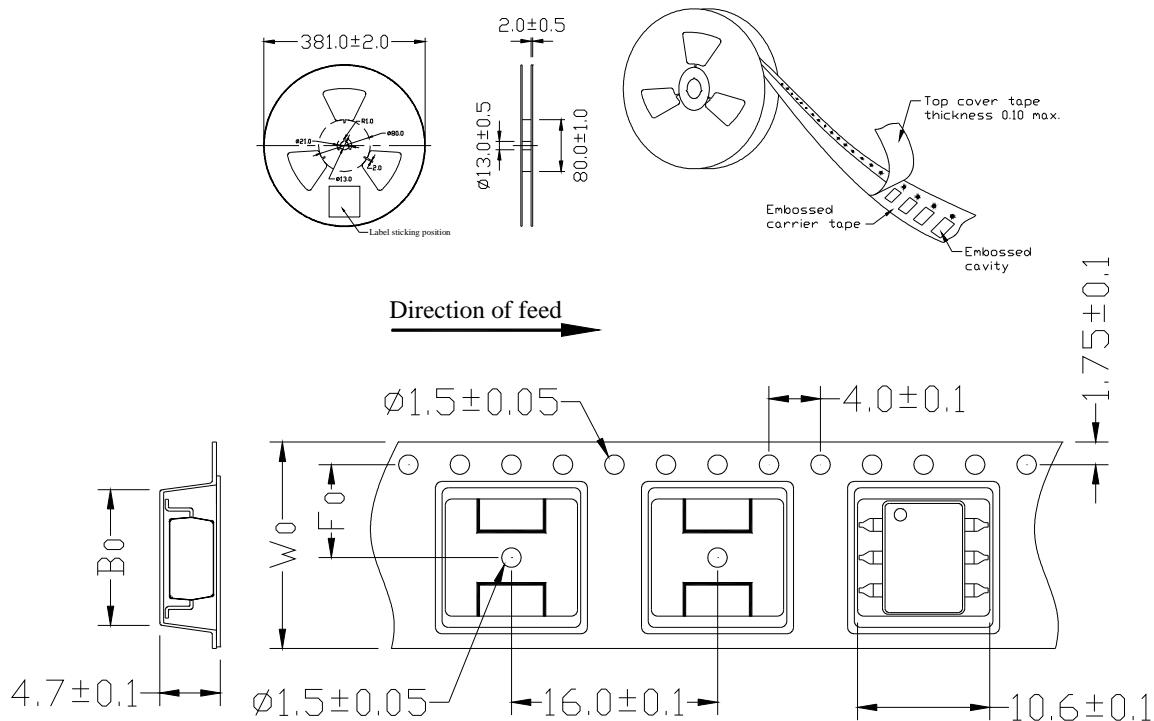
Reference Data



Voltage Vs. current characteristics
of output at MOS portion



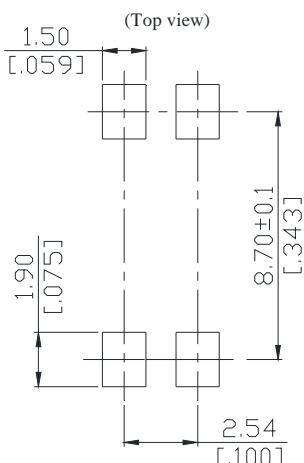
Taping Specifications for Surface Mount Devices



Unit: mm

TYPE	$B_0 \pm 0.1$	$F_0 \pm 0.1$	$W_0 \pm 0.1$	13" REEL/PCS
4P	5.3	7.5	16	1000
6P	9.4	7.5	16	1000
8P	10.3	11.5	24	1000

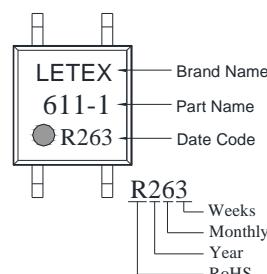
Recommended Mounting Pad



Unit : mm [inch]
Tolerance : ± 0.1

Marking

(Each photo MOS Relay shall be marked with the following information)



- Note:
- There shall be leader of 230 mm minimum which may consist of carrier and or cover tape follower by a minimum of 160 mm of carrier tape sealed with cover tape.
 - There shall be a minimum of 160 mm of empty component pockets sealed with cover tape.
 - Devices are pockets in accordance with EIA standard EIA-481-A and specifications given above.





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